

L Number	Hits	Search Text	DB	Time stamp
1	136	direct adj (copper or cu) adj bond\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 15:58
2	1552323	optic\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 15:58
3	3	(direct adj (copper or cu) adj bond\$4) and optic\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:00
4	562	(cu or copper) adj bonding	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:03
5	73882	electr\$5 adj optic\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:03
6	1	(direct adj (copper or cu) adj bond\$4) and (electr\$5 adj optic\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:03
7	9	((cu or copper) adj bonding) and (electr\$5 adj optic\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:06
8	1	(direct adj (copper or cu) adj bond\$4) and (electr\$5 adj optic\$5)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/12 16:06